# **IGBT - Field Stop II**

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications.

#### Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Optimized for High Speed Switching
- 10 µs Short Circuit Capability
- These are Pb–Free Devices

#### **Typical Applications**

- Solar Inverter
- Uninterruptible Power Inverter Supplies (UPS)
- Welding

#### ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CES</sub>	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι <sub>C</sub>	50 25	A
Pulsed collector current, T <sub>pulse</sub> limited by T <sub>Jmax</sub>	I <sub>CM</sub>	100	A
Gate-emitter voltage Transient gate-emitter voltage $(T_{pulse} = 5 \ \mu s, D < 0.10)$	$V_{GE}$	±20 ±30	V
Power Dissipation @ Tc = $25^{\circ}C$ @ Tc = $100^{\circ}C$	P <sub>D</sub>	385 192	W
Short Circuit Withstand Time $V_{GE}$ = 15 V, $V_{CE}$ = 500 V, $T_J \leq 150^\circ C$	T <sub>SC</sub>	10	μS
Operating junction temperature range	ТJ	T <sub>J</sub> –55 to +175	
Storage temperature range	T <sub>stg</sub>	-55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T <sub>SLD</sub>	260	°C

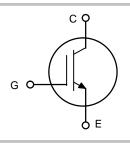
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

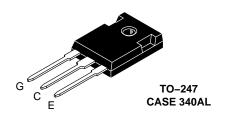


## **ON Semiconductor®**

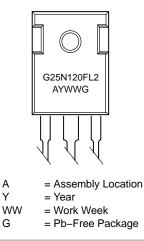
http://onsemi.com

25 A, 1200 V V<sub>CEsat</sub> = 2.0 V E<sub>off</sub> = 0.60 mJ





#### MARKING DIAGRAM



#### ORDERING INFORMATION

Device	Package	Shipping
NGTG25N120FL2WG	TO–247 (Pb–Free)	30 Units / Rail

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ extsf{ heta}JC}$	0.39	°C/W
Thermal resistance junction-to-ambient	$R_{\thetaJA}$	40	°C/W

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

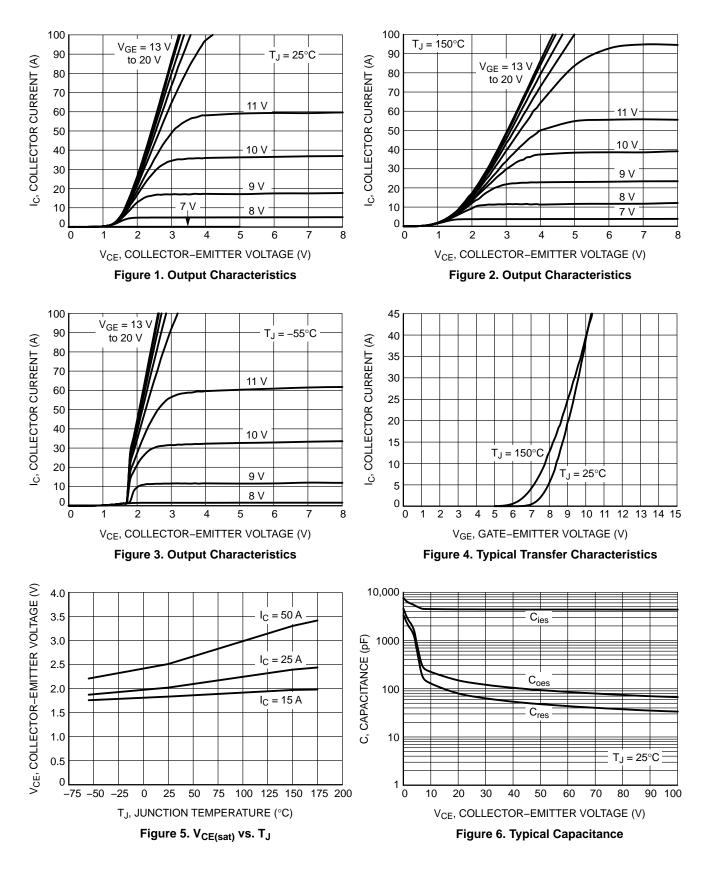
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	-		-			
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0 V, I_{C} = 500 \mu A$	V <sub>(BR)CES</sub>	1200	_	-	V
Collector-emitter saturation voltage	$V_{GE}$ = 15 V, I <sub>C</sub> = 25 A V <sub>GE</sub> = 15 V, I <sub>C</sub> = 25 A, T <sub>J</sub> = 175°C	V <sub>CEsat</sub>	_ _	2.00 2.40	2.40	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$ , $I_C = 400 \ \mu A$	V <sub>GE(th)</sub>	4.5	5.5	6.5	V
Collector–emitter cut–off current, gate– emitter short–circuited	V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 1200 V V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 1200 V, T <sub>J =</sub> 175°C	ICES	_ _	-	0.4 2	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE}$ = 20 V , $V_{CE}$ = 0 V	I <sub>GES</sub>	-	-	200	nA

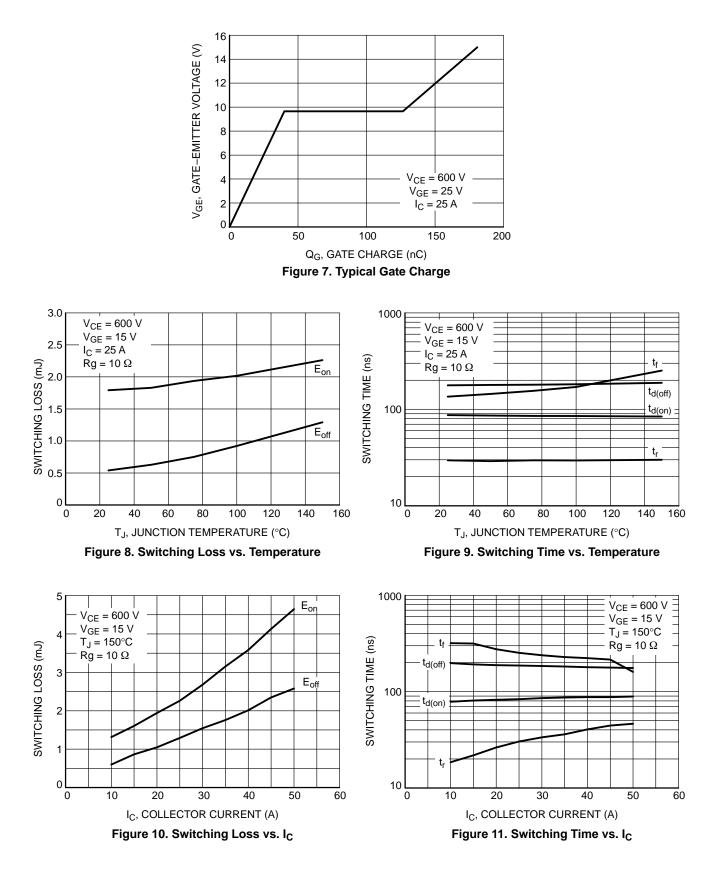
Input capacitance		Cies	-	4420	-	pF
Output capacitance	$V_{CE}$ = 20 V, $V_{GE}$ = 0 V, f = 1 MHz	C <sub>oes</sub>	-	151	-	
Reverse transfer capacitance		C <sub>res</sub>	-	81	-	
Gate charge total		Qg	-	178	-	nC
Gate to emitter charge	$V_{CE}$ = 600 V, $I_{C}$ = 25 A, $V_{GE}$ = 15 V	Q <sub>ge</sub>	-	39	-	
Gate to collector charge		Q <sub>gc</sub>	-	83	-	

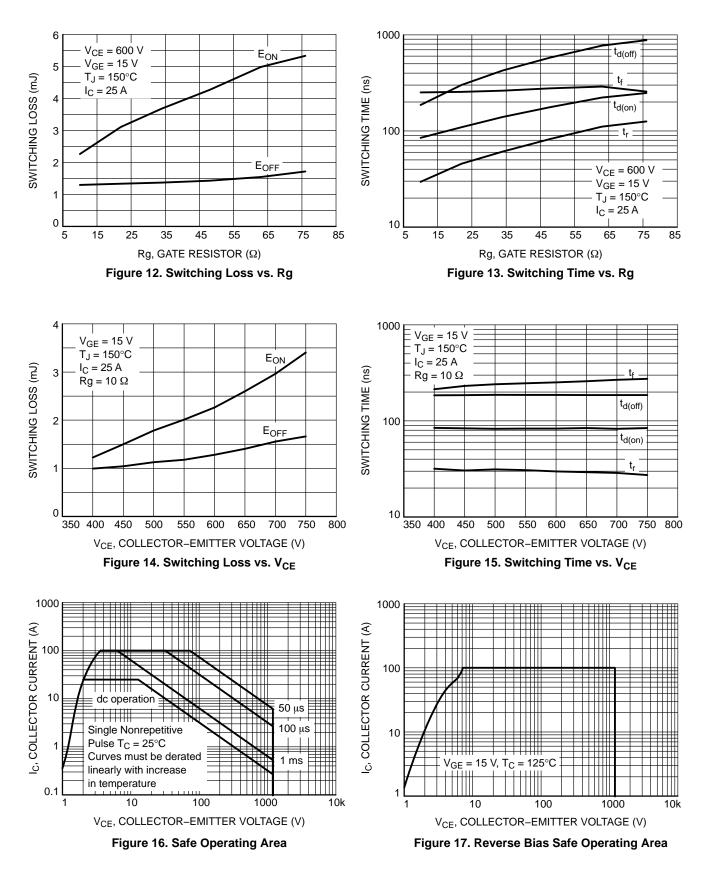
#### SWITCHING CHARACTERISTIC, INDUCTIVE LOAD

Turn-on delay time		t <sub>d(on)</sub>	-	87	-	ns
Rise time		t <sub>r</sub>	-	74	-	
Turn-off delay time	$T_J = 25^{\circ}C$ $V_{CC} = 600 V, I_C = 25 A$	t <sub>d(off)</sub>	-	179	-	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 25 \text{ A}$ $R_{c} = 10 \Omega$	t <sub>f</sub>	-	136	-	
Turn-on switching loss	$R_g = 10 \Omega$ $V_{GE} = 0 V/ 15V^*$	Eon	-	1.95	-	mJ
Turn-off switching loss		E <sub>off</sub>	-	0.60	-	
Total switching loss		E <sub>ts</sub>	-	2.55	-	
Turn-on delay time		t <sub>d(on)</sub>	-	84	-	ns
Rise time		t <sub>r</sub>	-	94	-	
Turn-off delay time	$T_{J} = 150^{\circ}C$ $V_{CC} = 600 \text{ V}, \text{ I}_{C} = 25 \text{ A}$	t <sub>d(off)</sub>	-	185	-	
Fall time	$V_{CC} = 600 \text{ V}, I_C = 25 \text{ A}$ $B_{c} = 10 \Omega$	t <sub>f</sub>	-	245	-	
Turn-on switching loss	$R_g = 10 \Omega$ $V_{GE} = 0 V/ 15V^*$	Eon	-	2.39	-	mJ
Turn-off switching loss		E <sub>off</sub>	-	1.26	-	
Total switching loss		E <sub>ts</sub>	-	3.65	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. \*Includes diode reverse recovery loss using NGTB25N120FL2WG.







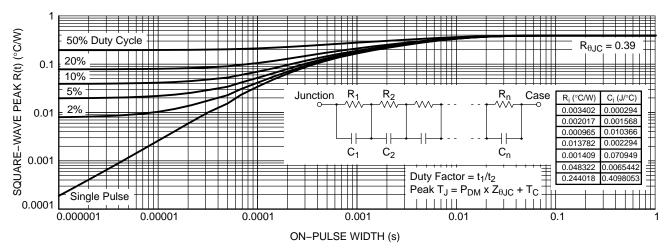


Figure 18. IGBT Die Self-heating Square-wave Duty Cycle Transient Thermal Response

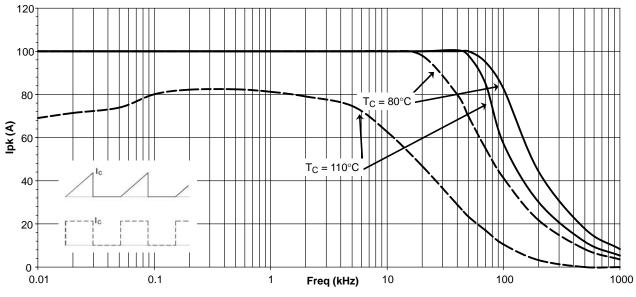


Figure 19. Collector Current vs. Switching Frequency

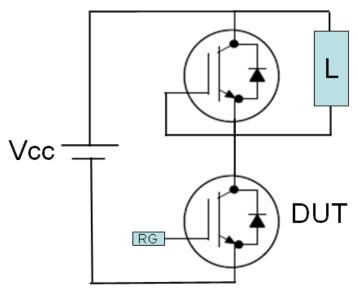


Figure 20. Test Circuit for Switching Characteristics

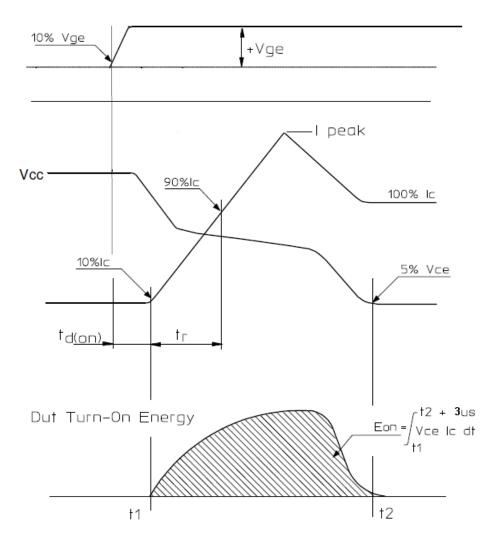


Figure 21. Definition of Turn On Waveform

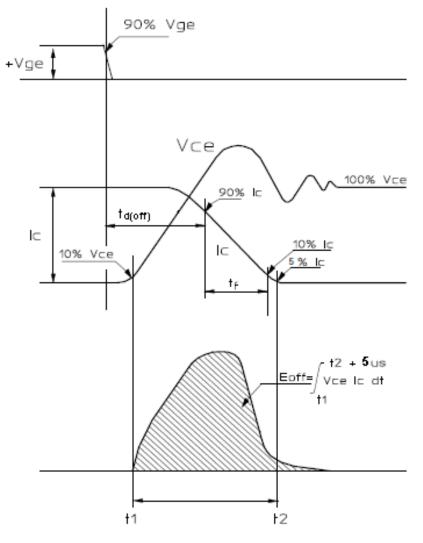
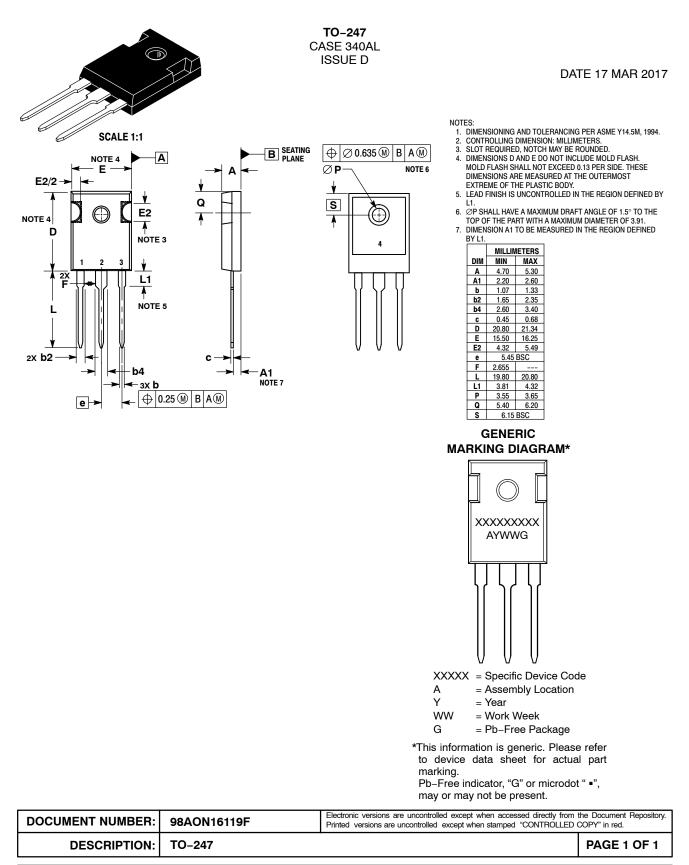


Figure 22. Definition of Turn Off Waveform

# **MECHANICAL CASE OUTLINE**

PACKAGE DIMENSIONS





ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor date sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use a a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor houteds for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

#### TECHNICAL SUPPORT

ON Semiconductor Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910 Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative